

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

| SUBMISSION TYPE: | NEW ASSIGNMENT | | | | | | | | | | | | |
|--|-----------------------------|---------------|----------------|-----------------|-----------------------------|-------------------|-------------------------|-------------------|-----------------|----------------|------------|---------------|------------|
| NATURE OF CONVEYANCE: | NUNC PRO TUNC ASSIGNMENT | | | | | | | | | | | | |
| EFFECTIVE DATE: | 02/23/2001 | | | | | | | | | | | | |
| CONVEYING PARTY DATA | | | | | | | | | | | | | |
| <table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Kin Pui Kwan</td> <td>02/23/2001</td> </tr> <tr> <td>Wing Him Lau</td> <td>02/23/2001</td> </tr> <tr> <td>Kwok Cheung Tsang</td> <td>02/23/2001</td> </tr> <tr> <td>Chun Ho Fan</td> <td>02/23/2001</td> </tr> <tr> <td>Neil McLellan</td> <td>02/23/2001</td> </tr> </tbody> </table> | | Name | Execution Date | Kin Pui Kwan | 02/23/2001 | Wing Him Lau | 02/23/2001 | Kwok Cheung Tsang | 02/23/2001 | Chun Ho Fan | 02/23/2001 | Neil McLellan | 02/23/2001 |
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| RECEIVING PARTY DATA | | | | | | | | | | | | | |
| <table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>ASAT Limited</td> </tr> <tr> <td>Street Address:</td> <td>138 Texaco Road, 14th Floor</td> </tr> <tr> <td>Internal Address:</td> <td>QPL Industrial Building</td> </tr> <tr> <td>City:</td> <td>Tsuen Wan, N.T.</td> </tr> <tr> <td>State/Country:</td> <td>HONG KONG</td> </tr> </table> | | Name: | ASAT Limited | Street Address: | 138 Texaco Road, 14th Floor | Internal Address: | QPL Industrial Building | City: | Tsuen Wan, N.T. | State/Country: | HONG KONG | | |
| Name: | ASAT Limited | | | | | | | | | | | | |
| Street Address: | 138 Texaco Road, 14th Floor | | | | | | | | | | | | |
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| State/Country: | HONG KONG | | | | | | | | | | | | |
| PROPERTY NUMBERS Total: 1 | | | | | | | | | | | | | |
| <table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 30%;">Property Type</th> <th style="width: 70%;">Number</th> </tr> </thead> <tbody> <tr> <td>Patent Number:</td> <td>6872661</td> </tr> </tbody> </table> | | Property Type | Number | Patent Number: | 6872661 | | | | | | | | |
| Property Type | Number | | | | | | | | | | | | |
| Patent Number: | 6872661 | | | | | | | | | | | | |
| CORRESPONDENCE DATA | | | | | | | | | | | | | |
| <p>Fax Number: (212)202-4765</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: (212) 671-1068</p> <p>Email: mwong@exeterlawgroup.com</p> <p>Correspondent Name: Mitchell M. Wong</p> <p>Address Line 1: 40 Wall Street, Floor 28</p> <p>Address Line 2: The Exeter Law Group LLP</p> <p>Address Line 4: New York, NEW YORK 10005</p> | | | | | | | | | | | | | |
| ATTORNEY DOCKET NUMBER: | 2000611 | | | | | | | | | | | | |

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PATENT
REEL: 024252 FRAME: 0878

NAME OF SUBMITTER:

Mitchell M. Wong

Total Attachments: 2

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WORLDWIDE ASSIGNMENT

WHEREAS, WE, **Kin Pui KWAN; Wing Him LAU; Kwok Cheung TSANG; Chun Ho FAN and Neil McLELLAN**, residing at respectively Rm 805, Ching On House, Tsz Ching Estate Kowloon, (HK); 18 Golden Bamboo Rd., East, Fairview Park, Yuen Long, (HK); Flat A, 1b/F, Block 8, Avon Park, Fauling, N.T. (HK); Flat E., 27/F, Blk 3, Lido Garden, Shamtseng, (HK) and 3 Tregunter Path, Branksom, Flat 3B, (HK) have invented certain new and useful improvements in an invention entitled **LEADLESS PLASTIC CHIP CARRIER WITH ETCH BACK PAD SINGULATION AND DIE ATTACH PAD ARRAY** for which an application for United States Letters Patent will be filed; and

WHEREAS, **ASAT LTD.**, a company organized and existing under the laws of the city of Hong Kong, having a place of business at QPL Industrial Building, 14th Floor, 138 Texaco Road, Tsuen Wan, New Territories Hong Kong is desirous of acquiring the full and exclusive right, title and interest in and to said application inclusive of any and all priority rights derived therefrom and the inventions therein disclosed, and in and to all Letters Patent, both United States and foreign, to be granted for said inventions;

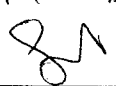
NOW, THEREFORE, for a valuable consideration, the receipt whereof is hereby acknowledged, WE, do hereby sell, assign, transfer, and set over unto the said Assignor, its successors and assigns, the full and exclusive right, title and interest in and to the aforesaid application for United States Letters Patent inclusive of any and all priority rights derived therefrom, and the invention therein disclosed, and in and to all Letters Patent and issues thereof which may be granted upon said application and in and to all Letters Patent which may be issued upon any substitutes, divisions, or continuations of said application, and in and to any and all Letters Patent which may be granted for said inventions in any foreign country or countries; the same to be held and enjoyed by the said Assignor for its own use and behoof, and for the use and behoof of its successors and assigns, to the full end of the term or terms for which said Letters Patent and reissues thereof may be granted as fully and entirely as the same would have been held and enjoyed by them had this assignment and sale not been made;

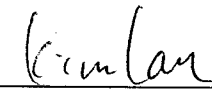
AND WE, hereby agree to execute, upon request, any and all further papers which may be necessary or desirable to enable the said Assignor, its successors and assigns, to file and prosecute said application, and any and all substitutes, divisions, or continuations thereof, and any and all reissues of the Letters Patent granted upon said application, or upon any substitutes, divisions, or continuations thereof, and any and all applications for foreign Letters Patent on said invention; and WE, further agree to execute any and all further papers which may be necessary or desirable to vest or perfect the title of said Assignor, its successors and assigns, in and to said application and the inventions therein disclosed, and in and to any and all Letters Patent and reissues thereof, both United States and foreign, which may be granted upon said application, and any substitutes, divisions, or continuations thereof, and upon any foreign applications.


AND WE, hereby authorize and request The Commissioner of Patents to issue each and every Letters Patent to be granted upon the aforesaid application for United States Letters Patent, and upon any and all substitutes, divisions, and continuations of said application, and each and every reissue of said Letters Patent, to the said Assignor, its successors and assigns, as the assignee of the entire right, title and interest therein, in accordance with this assignment.

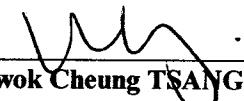
WITNESS my hand at Hong Kong
this 23rd day of February, 2001


Kin Pui KWAN

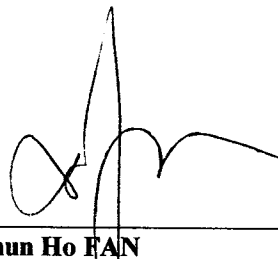
Witness: SUKI MA




Wing Him LAU

Witness: SUKI MA



Kwok Cheung TSANG

Witness: SUKI MA



Chun Ho FAN

Witness: SUKI MA



Neil McLELLAN

Witness: SUKI MA
